



US00D901404S

(12) **United States Design Patent** (10) **Patent No.:** **US D901,404 S**
Ice et al. (45) **Date of Patent:** **** Nov. 10, 2020**

(54) **PORTION OF A HEAT SINK**

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(**) Term: **15 Years**

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Related U.S. Application Data

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(51) **LOC (12) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/179; D8/395**

(58) **Field of Classification Search**
USPC D13/179; D26/138, 141, 152, 142, 63;
D8/394, 354, 395
CPC . H05K 7/20254; H05K 7/20418; F28F 3/022;
F28F 3/04; F28F 21/065; H01L 23/367;
H01L 23/3672; H01L 23/3677; H01L
23/36; H01L 23/4006; G02B 1/111; A61B
17/50; A61M 37/0015
See application file for complete search history.

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Primary Examiner — April Rivas

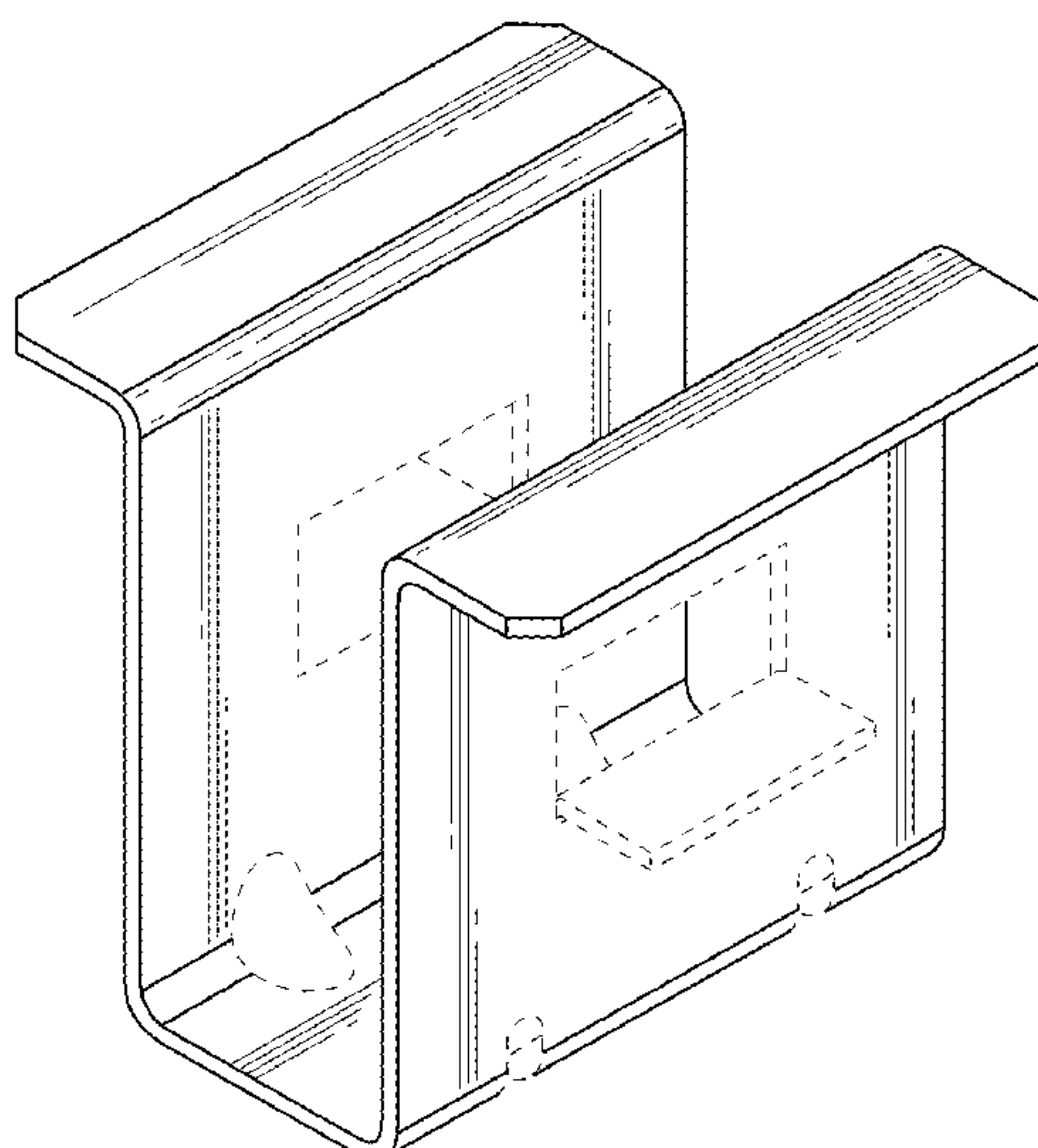
(57) **CLAIM**

The ornamental design for a portion of a heat sink, as shown and described.

DESCRIPTION

FIG. 1 is a top perspective view of the new design for a portion of a heat sink as seen from the front, top;
FIG. 2 is a top plan view thereof;
FIG. 3 is a bottom plan view thereof;
FIG. 4 is a front elevational view thereof;
FIG. 5 is a rear elevational view thereof;
FIG. 6 is a right side elevational view thereof, the opposite side view being a mirror image thereof; and,
FIG. 7 is a bottom perspective view thereof.
The broken line disclosure is for environmental purposes only and does not form a part of the claimed design.

1 Claim, 7 Drawing Sheets



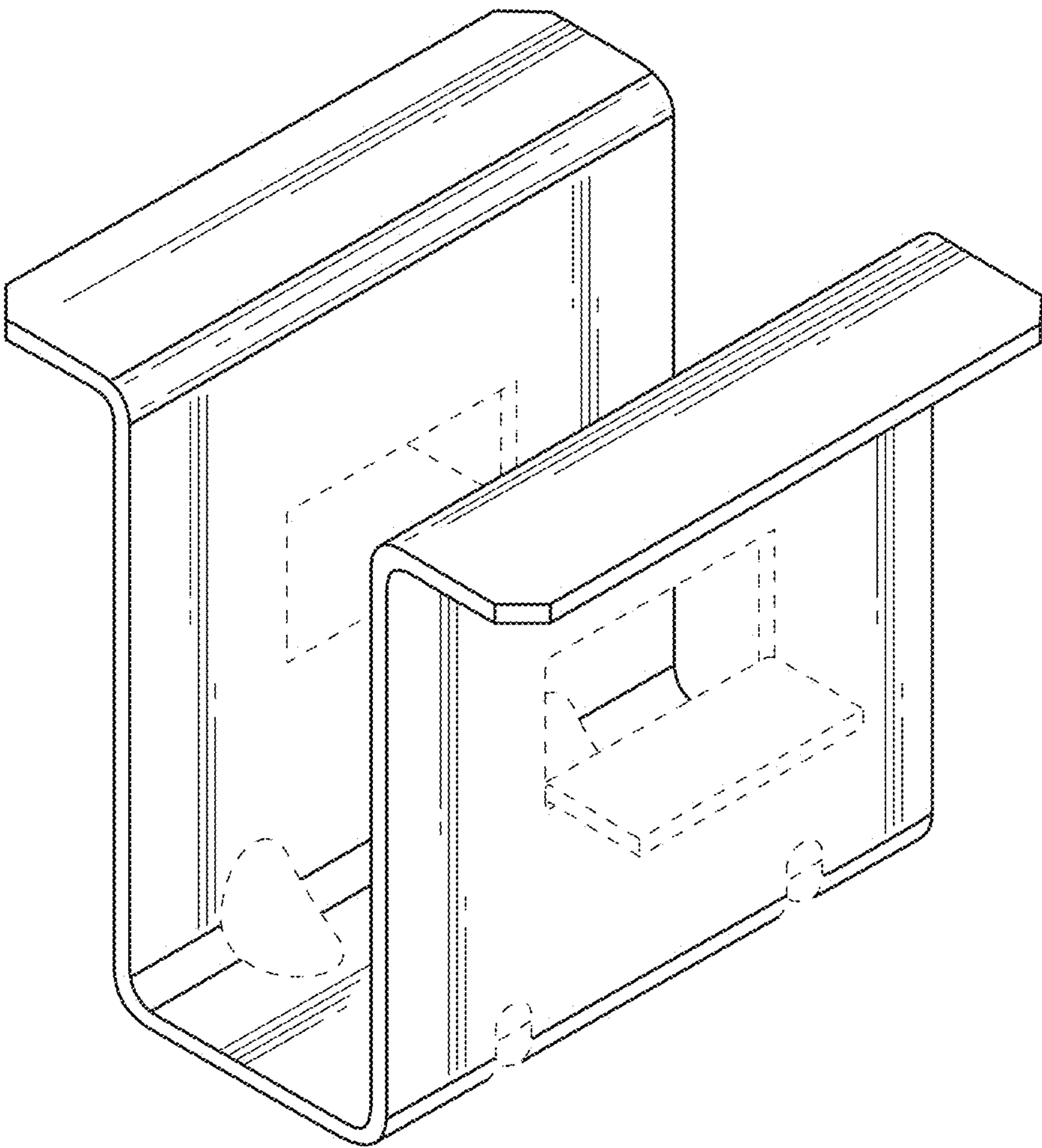


FIG. 1

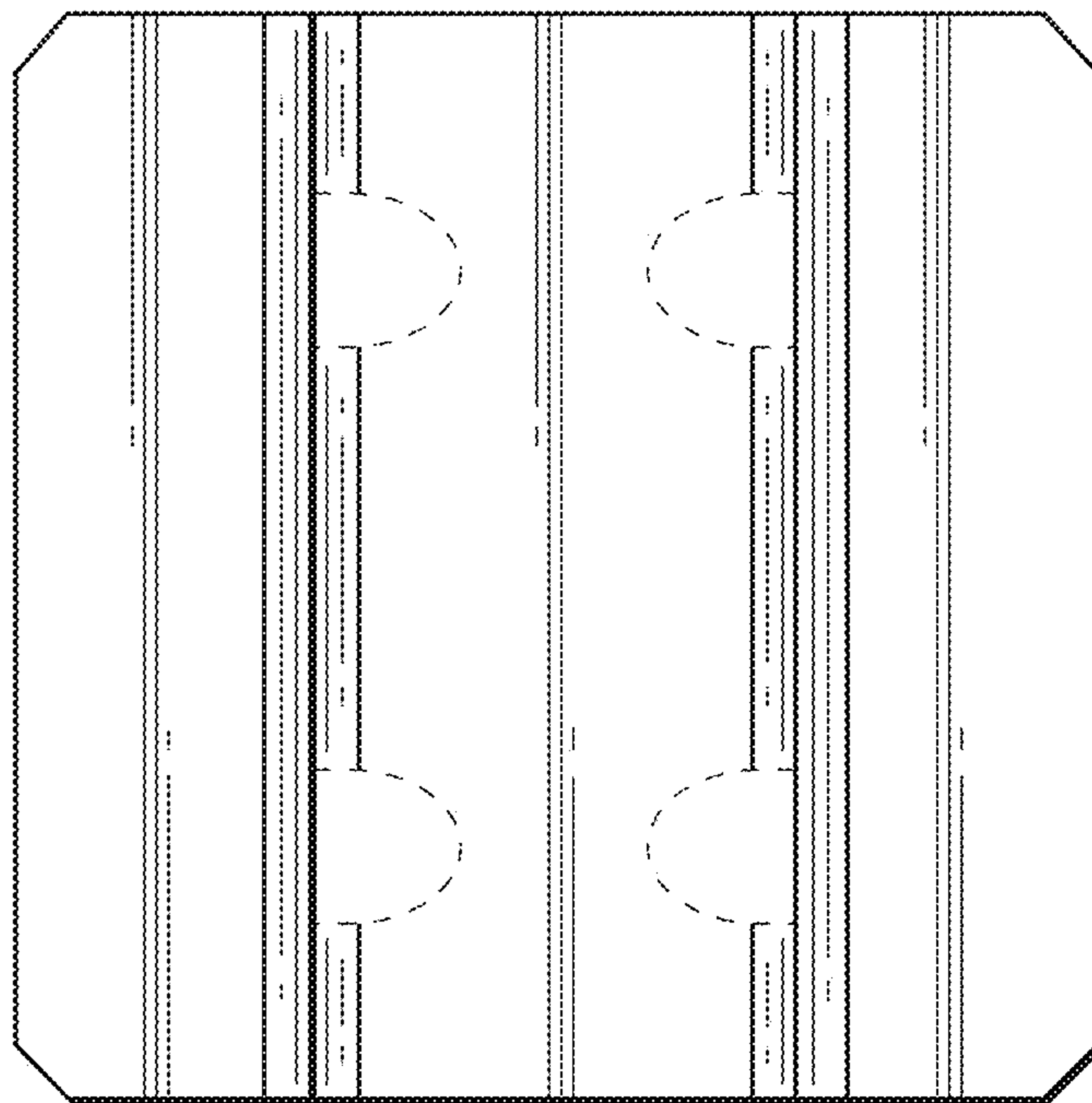


FIG. 2

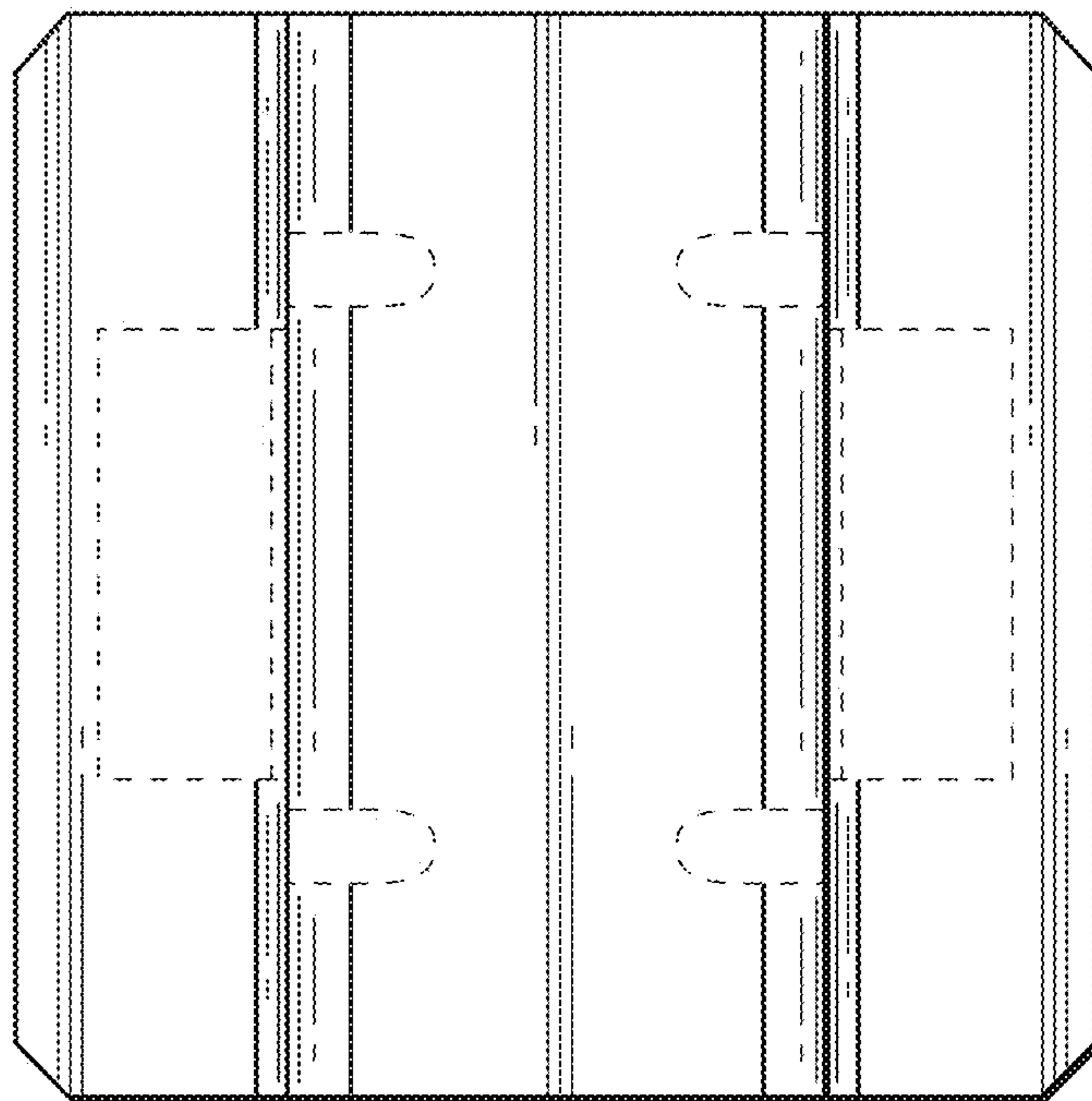


FIG. 3

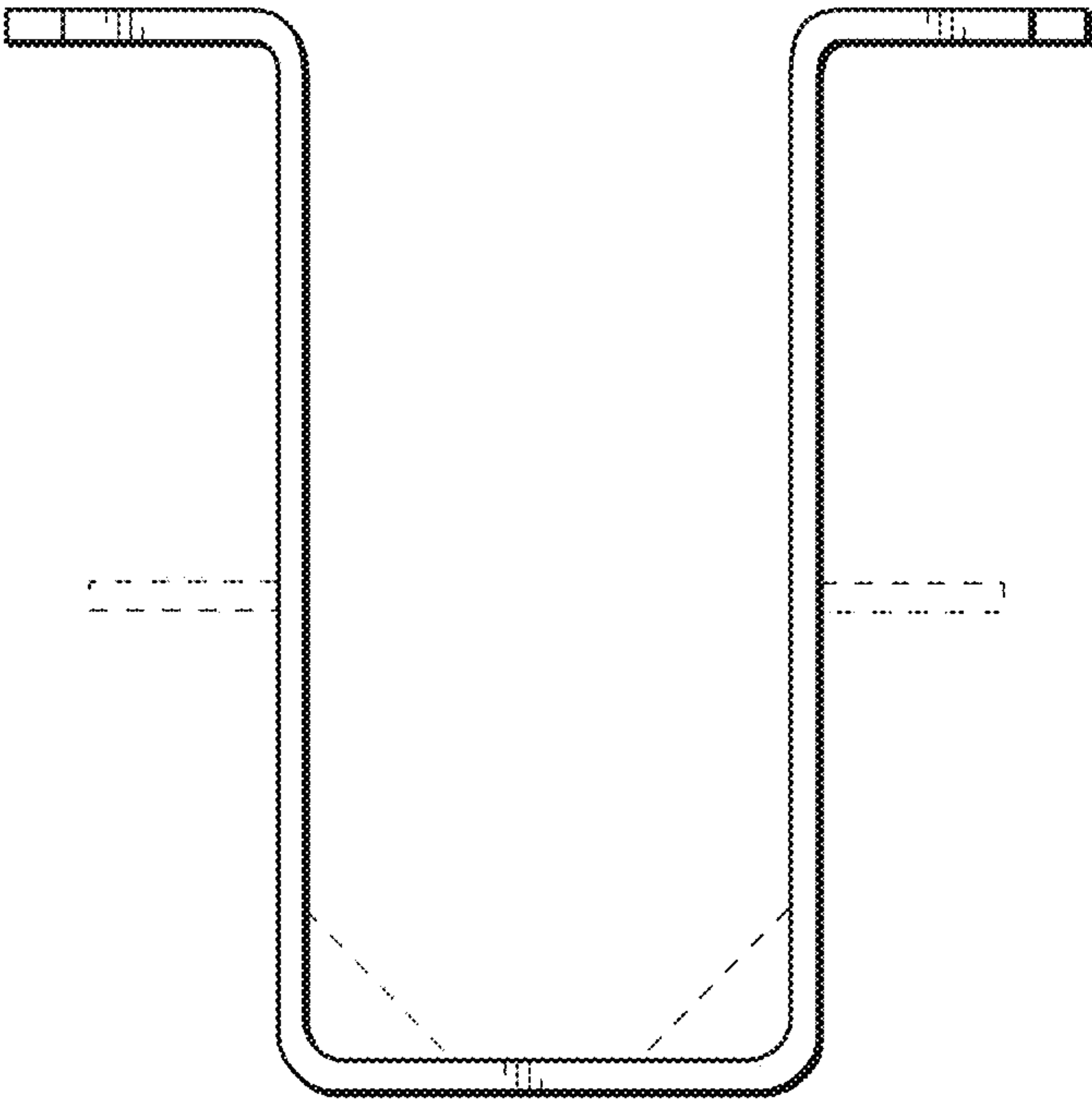


FIG. 4

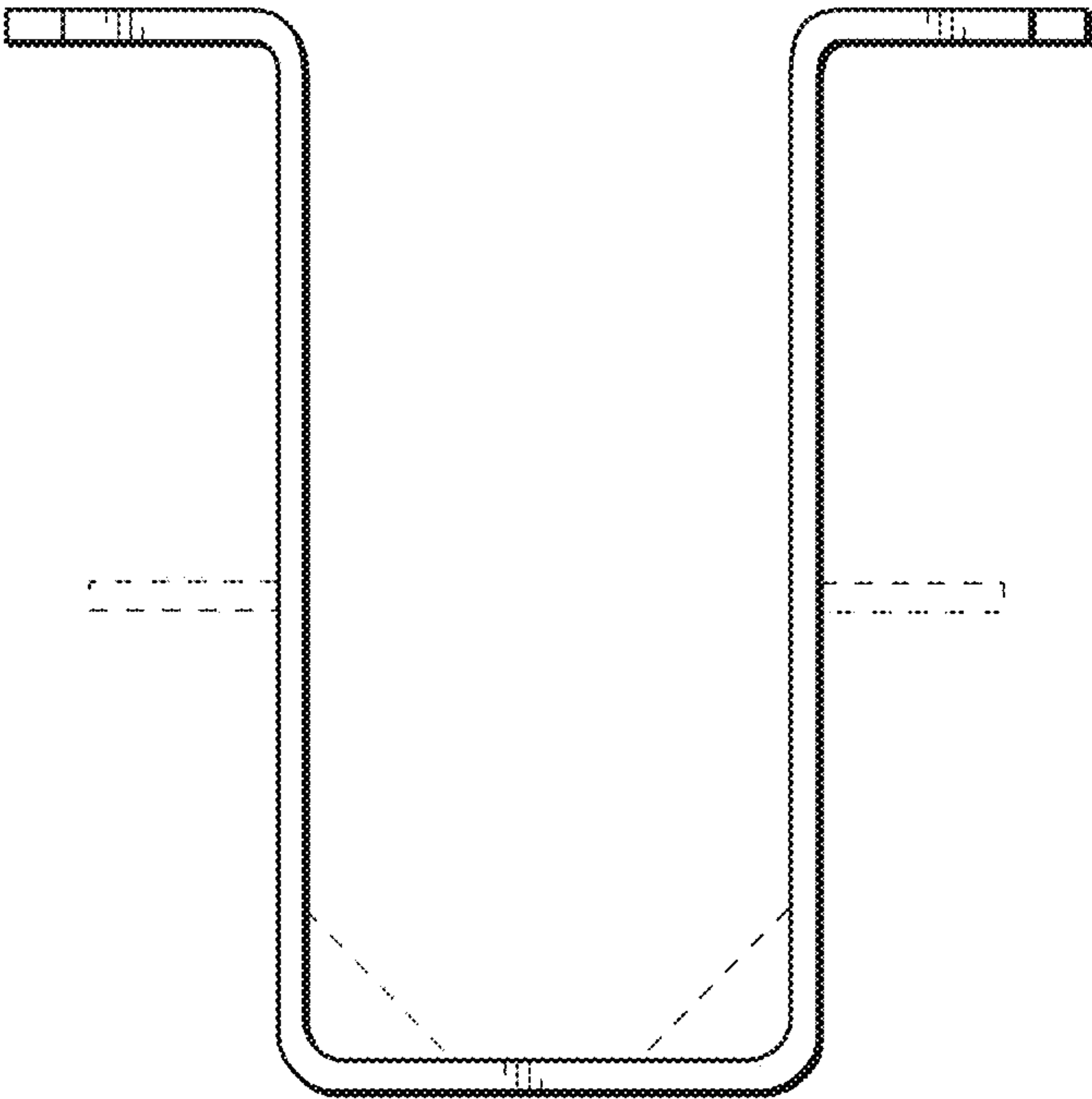


FIG. 5

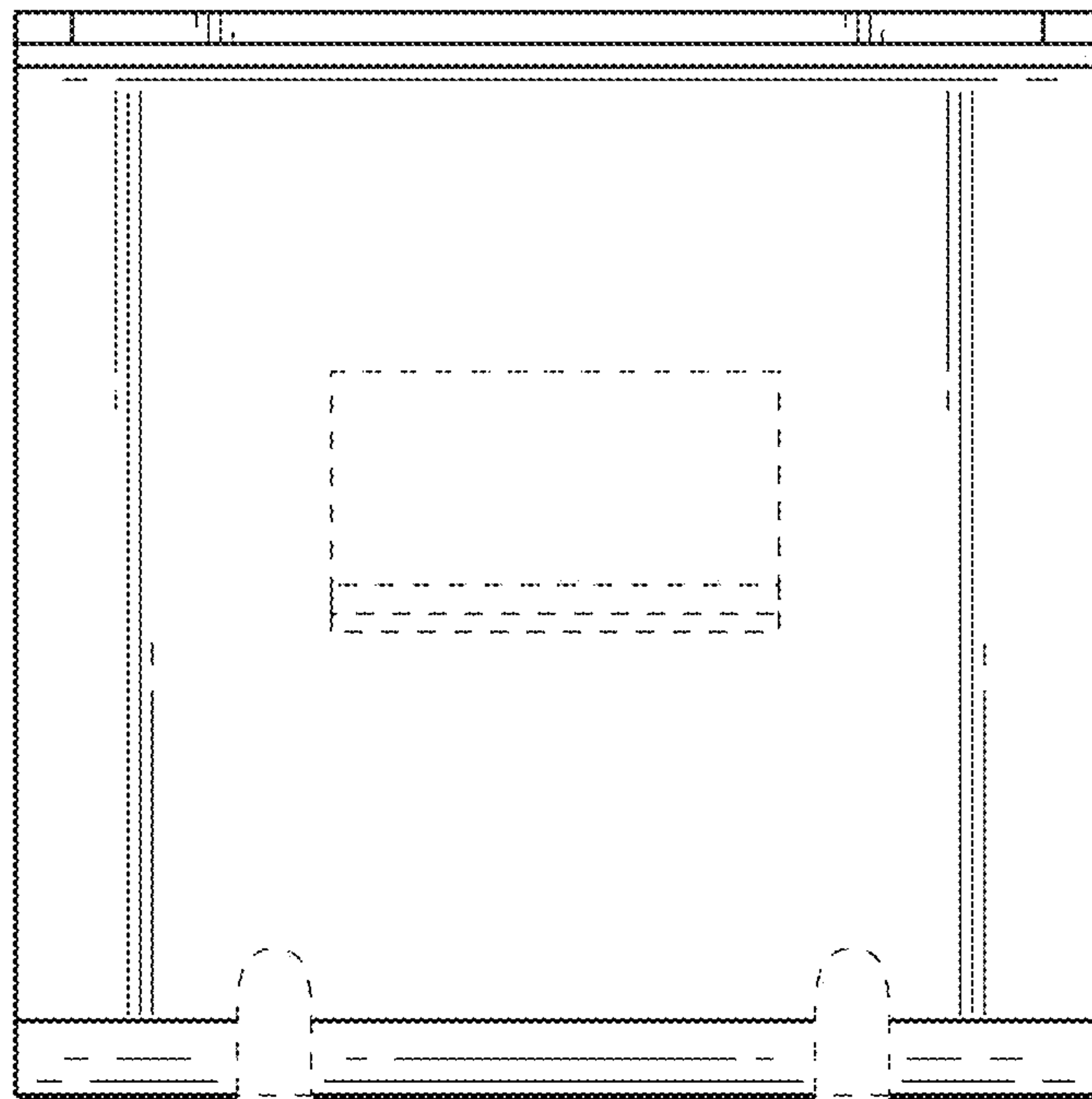


FIG. 6

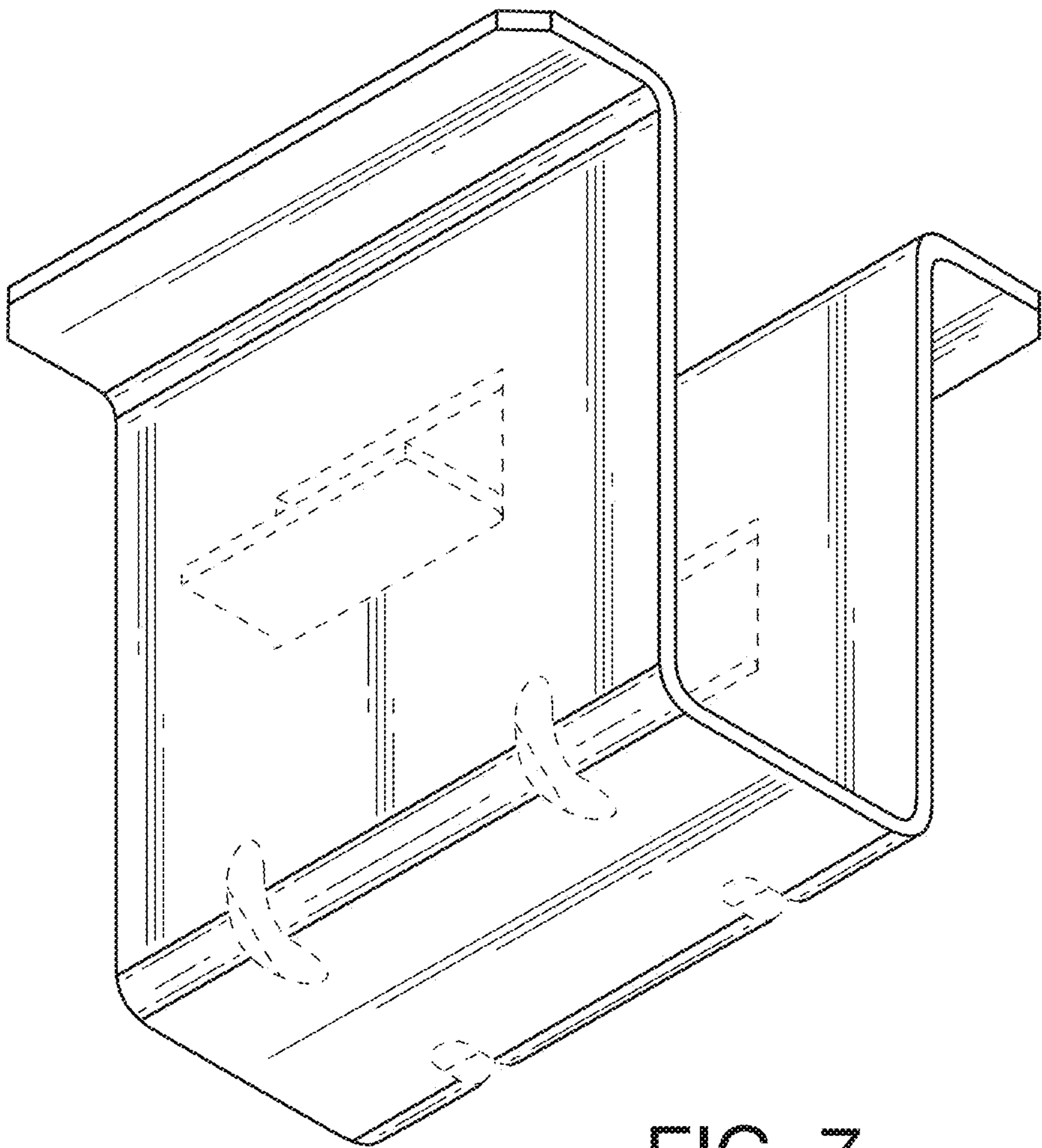


FIG. 7